

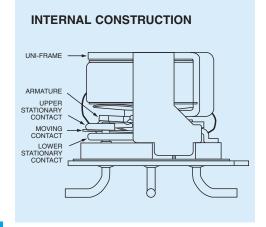


A Unit of Teledyne Electronics and Communications

CENTIGRID® SURFACE MOUNT COMMERCIAL RELAYS DPDT

SERIES S172

SERIES DESIGNATION	RELAY TYPE	
S172	DPDT basic relay	
S172D	DPDT relay with internal diode for coil transient suppression	



DESCRIPTION

The S172 surface mount Centigrid® relay is an ultraminiature, hermetically sealed, armature relay for commercial applications. Its low profile height (.470) and .100" grid spaced terminals make it an ideal choice where extreme packaging density and/or close PC board spacing are required. The specially formed leads are pre-tinned to make the relays ideal for all types of surface-mount solder reflow processes.

The basic design and internal structure are similar to Teledyne's DPDT 114 Centigrid® relay. Unique construction features and manufacturing techniques provide overall high reliability and excellent resistance to environmental extremes:

- · All welded construction.
- Unique uni-frame design providing high magnetic efficiency and mechanical rigidity
- High force/mass ratios for resistance to shock and vibration.
- Advanced cleaning techniques provide maximum assurance of internal cleanliness.
- Precious metal alloy contact material with gold plating assures excellent high current and dry circuit switching capabilities.

The S172D relay has an internal discrete silicon diode for coil transient suppression.

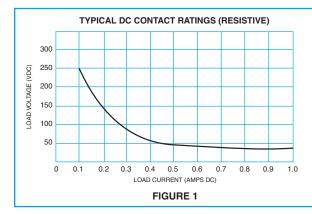
ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS -65°C to +125°C Storage Temperature (Ambient) -55°C to +85°C Operating Vibration 10 g's to 500 Hz (General Note 1) Shock 30 g's, (General Note 1) 6 msec, half-sine **Enclosure** Hermetically sealed Weight 0.15 oz. (4.3g) max. 260°C max. temp. **Reflow Temperature** 1 min. max.

SERIES S172 GENERAL ELECTRICAL SPECIFICATIONS (@25°C) (Notes 2 & 3)

Contact Arrangement	2 Form C (DPDT)				
Rated Duty	Continuous				
Contact Resistance	0.15 ohm max. before life; 0.3 ohm max. after life at 1A/28Vdc (measured 1/8" from header)				
Contact Load Ratings (DC) (See Fig. 1 for other DC resistive voltage/current ratings)	Resistive: 1 Amp/28Vdc Inductive: 200 mA/28Vdc (320 mH) Lamp: 100 mA/28Vdc Low Level: 10 to 50 µA/10 to 50mV				
Contact Life Ratings	5,000,000 cycles (typical) at low level 500,000 cycles (typical) at 0.5A/28Vdc resistive 100,000 cycles min. at all other loads specified above				
Contact Overload Rating	2A/28Vdc Resistive (100 cycles min.)				
Contact Carry Rating	Contact factory				
Operate Time	6.0 msec max. at nominal rated coil voltage				
Release Time	S172: 3.0 msec max. S172D: 6.0 msec max.				
Contact Bounce	1.5 msec max.				
Intercontact Capacitance	0.4 pf typical				
Insulation Resistance	1,000 megohms min. between mutually isolated terminals				
Dielectric Strength	Atmospheric pressure: 300 Vrms/60Hz				
Negative Coil Transient (Vdc) S172D		2.0 max			
Diode P.I.V. (Vdc) S172D		60 min.			

DETAILED ELECTRICAL SPECIFICATIONS (@25°C) (Note 3)

BASE PART NUMBERS		S172-5 S172D-5	S172-12 S172D-12	S172-26 S172D-26
Coil Voltage (Vdc)	Nom.	5.0	12.0	26.5
	Max.	5.8	16.0	32.0
Coil Resistance (Ohms ±20%)		64	400	1600
Pick-up Voltage (Vdc, Max.) Pulse Operation		3.8	9.0	18.0
Coil Operating Power at Nominal Voltage (Milliwatts)		405	360	440



GENERAL NOTES

- 1. Relay contacts will exhibit no chatter in excess of 10 μ sec or transfer in excess of 1 μ sec.
- "Typical" characteristics are based on available data and are best estimates. No on-going verification tests are performed.
- 3. Unless otherwise specified, parameters are initial values.
- 4. Position of leads as they emerge from relay base.
- 5. Leads will fit noted pad layout with no overhang.
- 6. Lead ends are coplanar within .008" wide tolerance zone.
- Terminals coated with SN60 or SN63 solder per QQ-S-571. Base material exposed at sheared end of leads.

